Accepted Manuscript

<text><section-header><section-header><section-header><section-header>

Title: A novel approach of chemical mechanical polishing for a titanium alloy using an environment-friendly slurry

Authors: Zhenyu Zhang, Zhifeng Shi, Yuefeng Du, Zhijian Yu, Liangchao Guo, Dongming Guo

 PII:
 S0169-4332(17)32396-6

 DOI:
 http://dx.doi.org/doi:10.1016/j.apsusc.2017.08.064

 Reference:
 APSUSC 36901

 To appear in:
 APSUSC

 Received date:
 29-6-2017

 Revised date:
 4-8-2017

 Accepted date:
 7-8-2017

Please cite this article as: Zhenyu Zhang, Zhifeng Shi, Yuefeng Du, Zhijian Yu, Liangchao Guo, Dongming Guo, A novel approach of chemical mechanical polishing for a titanium alloy using an environment-friendly slurry, Applied Surface Sciencehttp://dx.doi.org/10.1016/j.apsusc.2017.08.064

This is a PDF file of an unedited manuscript that has been accepted for publication. As a service to our customers we are providing this early version of the manuscript. The manuscript will undergo copyediting, typesetting, and review of the resulting proof before it is published in its final form. Please note that during the production process errors may be discovered which could affect the content, and all legal disclaimers that apply to the journal pertain.

A novel approach of chemical mechanical polishing for a titanium alloy using an environment-friendly slurry

Zhenyu Zhang^{a,*}, Zhifeng Shi^a, Yuefeng Du^{a,b}, Zhijian Yu^a, Liangchao Guo^{a,b}, Dongming Guo^a

^a Key Laboratory for Precision and Non-Traditional Machining Technology of Ministry of

Education, Dalian University of Technology, Dalian 116024, China.

^b Key laboratory of Marine Materials and Related Technologies, Ningbo Institute of Materials

Technology and Engineering, Chinese Academy of Sciences, Ningbo 315201, China.

* Corresponding author.

E-mail address: zzy@dlut.edu.cn (Z.Y. Zhang).

Highlights

- A novel approach of chemical mechanical polishing is proposed for a Ti alloy using an environment-friendly slurry.
- The surface roughness R_a of 0.68 nm is obtained, which is lower than those previously reported for a Ti alloy.
- Corrosion potential agrees well with the polished surface quality of Ti-6Al-4V.

Abstract: In this study, a novel approach of CMP is developed using an environment-friendly slurry consisting of silica, hydrogen peroxide (H_2O_2), malic acid and deionized water. This is different from the traditional polishing, in which hazardous chemicals are used for Ti alloys. The surface roughness R_a of 0.68 nm is obtained over a measurement area of 70×53 µm², which is lower than those previously reported for a Ti alloy. This is polished by the developed optimal CMP slurry. Polishing mechanism is investigated using electrochemical and X-ray photoelectron (XPS) measurements. H_2O_2 dominates the corrosion process during CMP using the developed environment-friendly slurry. Corrosion current of H_2O_2 is consistent with the reactants of titania, alumina and vanadia formed on the surfaces of Ti-6Al-4V after CMP. Corrosion potential agrees well with the polished surface quality of Ti-6Al-4V. Chemical reaction equations are proposed

Download English Version:

https://daneshyari.com/en/article/5346802

Download Persian Version:

https://daneshyari.com/article/5346802

Daneshyari.com